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STD80N4F6 Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage	40	V
V _{GS}	Gate-source voltage	± 20	٧
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25 °C	80	Α
I _D ⁽¹⁾	Drain current (continuous) at T _C = 100 °C	56	Α
I _{DM} ⁽²⁾	Drain current (pulsed)	320	Α
P _{TOT}	Total dissipation at T _C = 25 °C	70	W
I _{AV}	Avalanche current, repetitive or not-repetitive (pulse width limited by T _{Jmax})	40	Α
E _{AS}	Single pulse avalanche energy (starting $T_j = 25$ °C, $I_D = I_{AV}$, $V_{DD} = 25$ V)	149	mJ
	Derating factor 0.47		W/°C
T _{stg}	Storage temperature	-55 to 175	°C
T _j	Max. operating junction temperature	-55 to 175	°C

^{1.} Current limited by package.

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	2.14	°C/W
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-pcb max	50	°C/W

^{1.} When mounted on FR-4 board of inch 2 , 2 oz Cu

^{2.} Pulse width limited by safe operating area

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2 Electrical characteristics

(T_C = 25 °C unless otherwise specified)

Table 4. On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_D = 250 \mu\text{A}, V_{GS} = 0$	40			V
1	Zero gate voltage	V _{DS} = 40 V			1	μΑ
I _{DSS}	drain current (V _{GS} = 0)	V _{DS} = 40 V, T _C =125 °C			100	μΑ
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 20 V			± 100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	2		4	V
R _{DS(on)}	Static drain-source on-resistance	V _{GS} = 10 V, I _D = 40 A		5.5	6	mΩ

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	2150	-	pF
C _{oss}	Output capacitance	V _{DS} = 25 V, f = 1 MHz,	-	335	-	pF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0$	-	160	-	pF
Q_g	Total gate charge	V _{DD} = 20 V, I _D = 80 A,	-	36	-	nC
Q_{gs}	Gate-source charge	V _{GS} = 10 V	-	11	ı	nC
Q_{gd}	Gate-drain charge	(see Figure 14)	-	9	-	nC

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
t _{d(on)}	Turn-on delay time		-	10.5	-	ns
t _r	Rise time	$V_{DD} = 20 \text{ V}, I_D = 40 \text{ A},$ $R_G = 4.7 \Omega, V_{GS} = 10 \text{ V}$	-	7.6	-	ns
t _d (off)	Turn-off delay time	$H_G = 4.7 \Omega$, $V_{GS} = 10 V$ (see <i>Figure 15</i>)	-	46.1	-	ns
t _f	Fall time		-	11.9	-	ns



Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		80	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		320	Α
V _{SD} (2)	Forward on voltage	I _{SD} = 40 A, V _{GS} = 0	-		1.3	V
t _{rr}	Reverse recovery time		-	41.1		ns
Q _{rr}	Reverse recovery charge	$I_{SD} = 80 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s}$ $V_{DD} = 32 \text{ V (see Figure 17)}$	-	43.6		nC
I _{RRM}	Reverse recovery current	= 52 · (556 / igalo //)	-	2.1		Α

^{1.} Pulse width limited by safe operating area.



^{2.} Pulsed: pulse duration = 300 μ s, duty cycle 1.5%

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Figure 2. Safe operating area

ΙD (A) 100 100µs 10 1ms 10ms Tj=175°C Tc=25°C Single pulse 10 VDS(V) 0.1

Figure 3. Thermal impedance

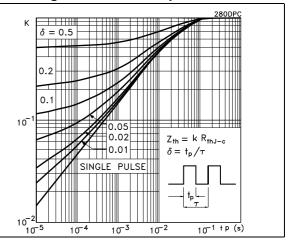
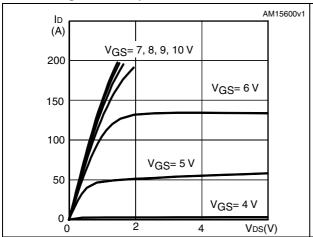


Figure 4. Output characteristics

Figure 5. Transfer characteristics



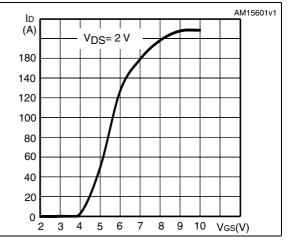
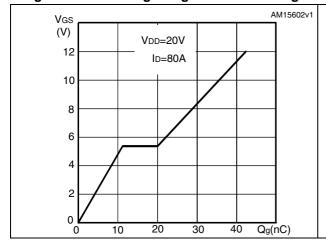
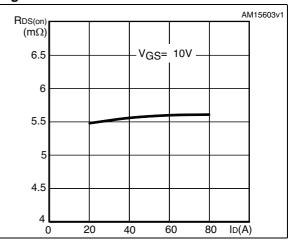


Figure 6. Gate charge vs gate-source voltage

Figure 7. Static drain-source on-resistance

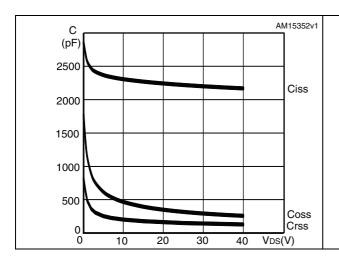




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Figure 8. Capacitance variations

Figure 9. Drain-source diode forward characteristics



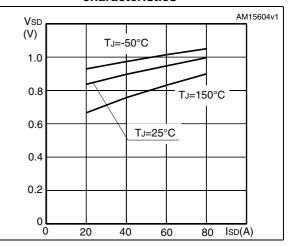
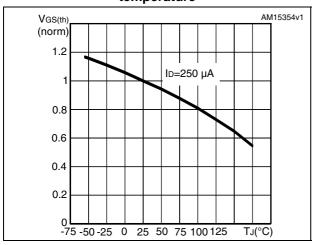


Figure 10. Normalized gate threshold voltage vs temperature

Figure 11. Normalized on-resistance vs temperature



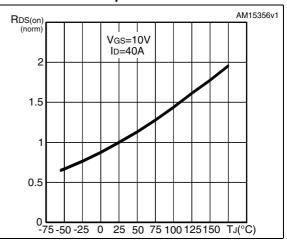
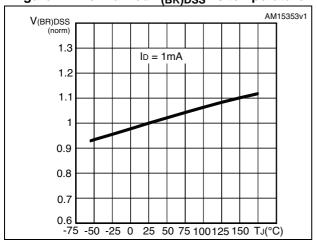


Figure 12. Normalized v_{(BR)DSS} vs temperature





Test circuits STD80N4F6

3 Test circuits

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

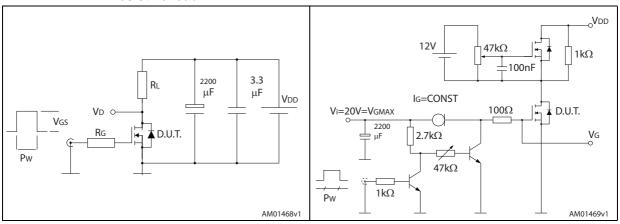


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped inductive load test circuit

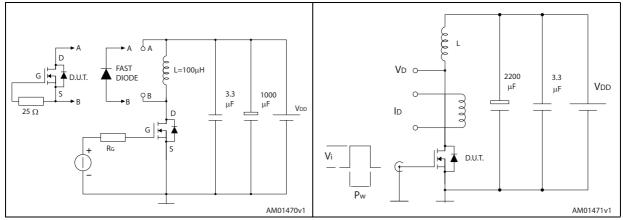
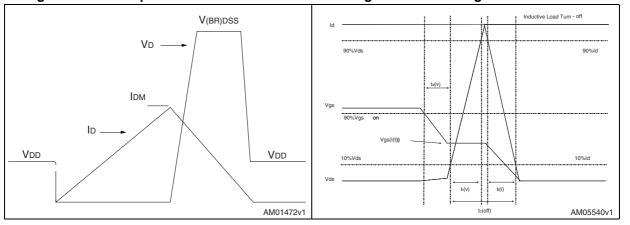


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform



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4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.



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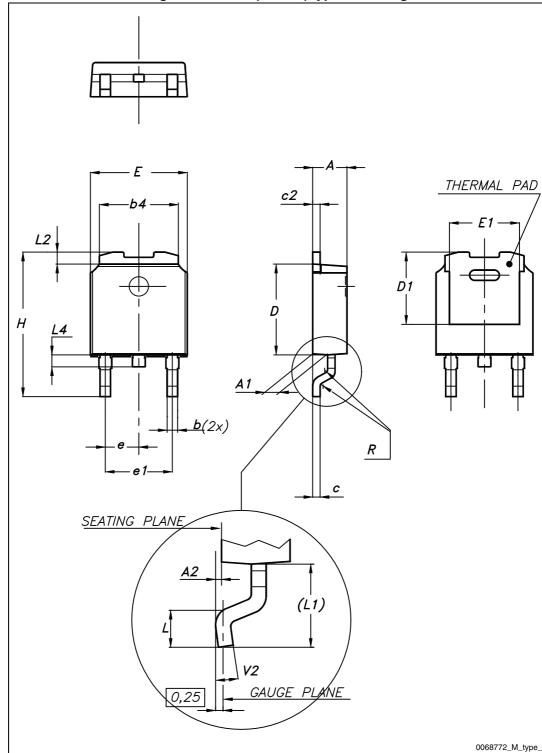


Figure 19. DPAK (TO-252) type A drawing

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Table 8. DPAK (TO-252) type A mechanical data

Dim	14515 61 51 711 (15	mm	
Dim.	Min.	Тур.	Max.
Α	2.20		2.40
A1	0.90		1.10
A2	0.03		0.23
b	0.64		0.90
b4	5.20		5.40
С	0.45		0.60
c2	0.48		0.60
D	6.00		6.20
D1		5.10	
E	6.40		6.60
E1		4.70	
е		2.28	
e1	4.40		4.60
Н	9.35		10.10
L	1.00		1.50
(L1)		2.80	
L2		0.80	
L4	0.60		1.00
R		0.20	
V2	0°		8°



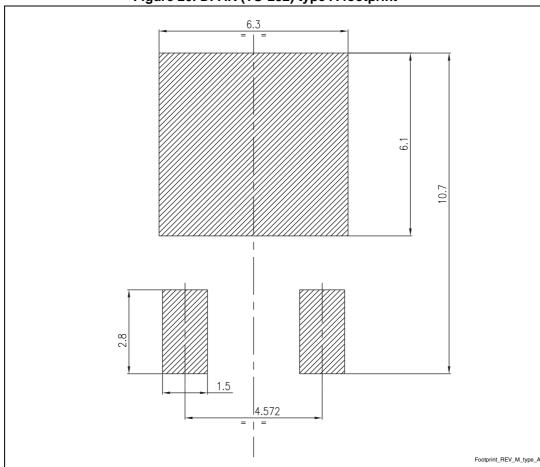


Figure 20. DPAK (TO-252) type A footprint ^(a)

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a. All dimensions are in millimeters

5 Packaging mechanical data

Figure 21. Tape for DPAK (TO-252)

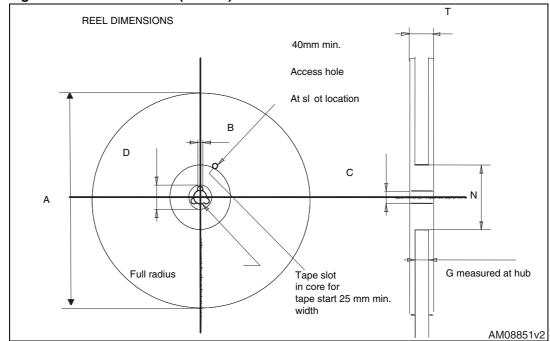


Figure 22. Reel for DPAK (TO-252)

Table 9. DPAK (TO-252) tape and reel mechanical data

	Таре			Reel		
Dim.	mm		Dim.	mm		
Dim.	Min.	Max.	Dilli.	Min.	Max.	
A0	6.8	7	Α		330	
В0	10.4	10.6	В	1.5		
B1		12.1	С	12.8	13.2	
D	1.5	1.6	D	20.2		
D1	1.5		G	16.4	18.4	
Е	1.65	1.85	N	50		
F	7.4	7.6	Т		22.4	
K0	2.55	2.75				
P0	3.9	4.1		Base qty.	2500	
P1	7.9	8.1		Bulk qty.	2500	
P2	1.9	2.1				
R	40					
Т	0.25	0.35				
W	15.7	16.3				

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STD80N4F6 Revision history

6 Revision history

Table 10. Document revision history

Date	Revision	Changes
03-Mar-2014	1	Initial release. The part number previously included in datasheet DocID023839

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